

HIT673

Silicon PNP Epitaxial

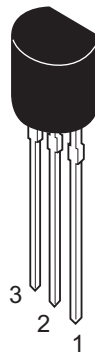
REJ03G1608-0100
Rev.1.00
Nov 28, 2007

Features

- Low frequency power amplifier
- Complementary pair with HIT1213

Outline

RENESAS Package code: PRSS0003DA-A
(Package name: TO-92 (1))



1. Emitter
2. Collector
3. Base

Absolute Maximum Ratings

(Ta = 25°C)

| Item | Symbol | Ratings | Unit |
|------------------------------|-------------------------------|-------------|------|
| Collector to base voltage | V_{CBO} | -50 | V |
| Collector to emitter voltage | V_{CEO} | -50 | V |
| Emitter to base voltage | V_{EBO} | -5 | V |
| Collector current | I_C | -0.5 | A |
| Collector peak current | $I_{C(peak)}$ ^{Note} | -1.0 | A |
| Collector power dissipation | P_C | 0.4 | W |
| Junction temperature | T_j | 150 | °C |
| Storage temperature | T_{stg} | -55 to +150 | °C |

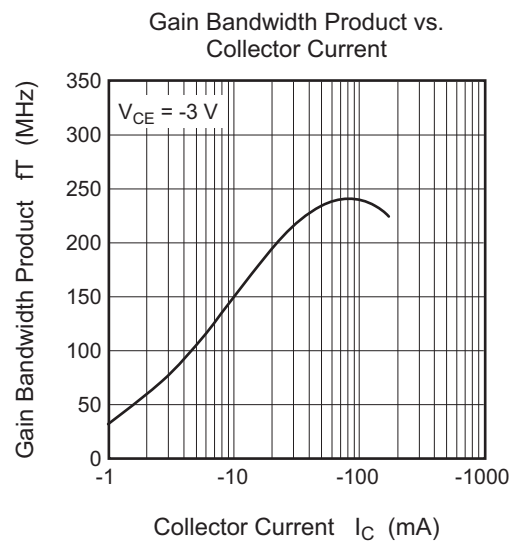
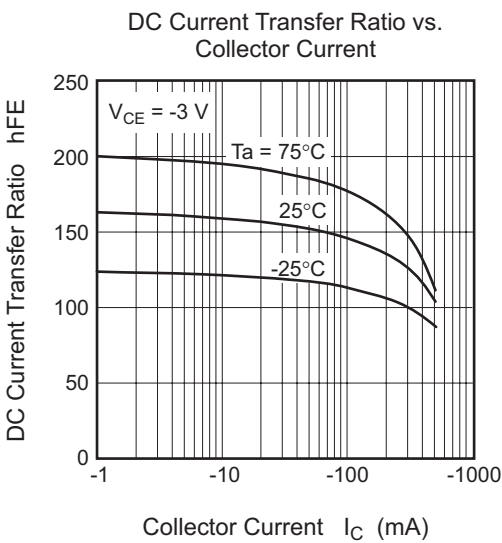
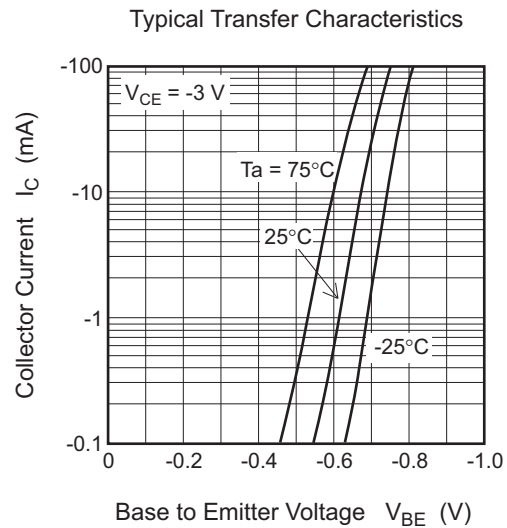
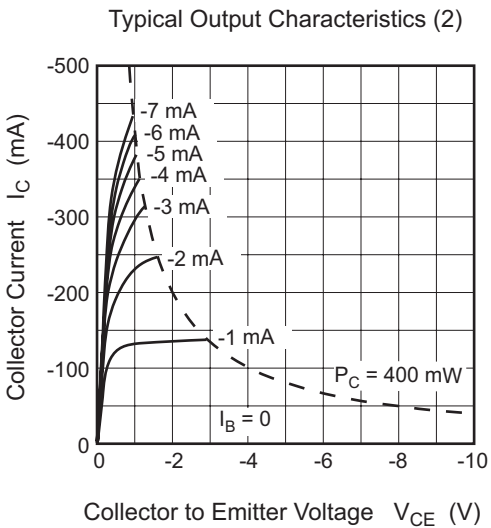
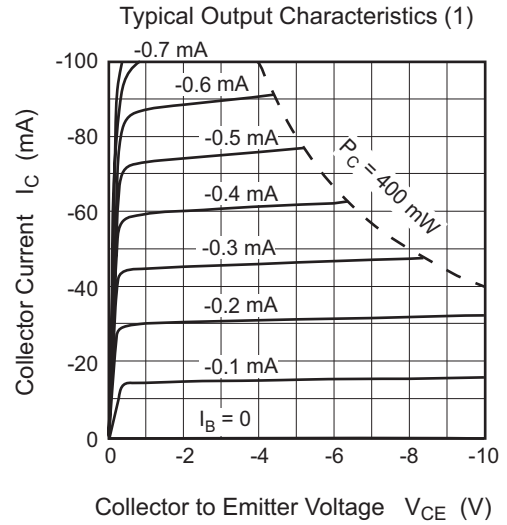
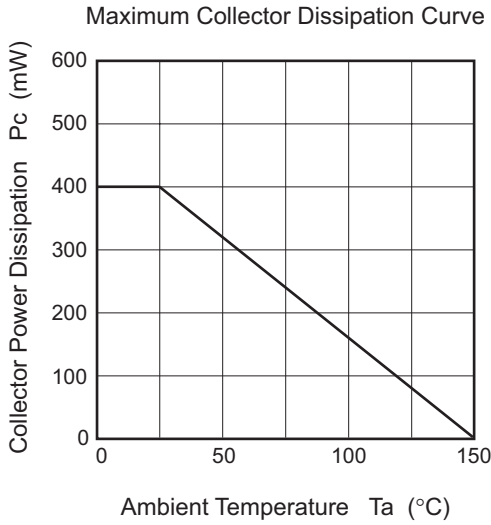
Note: PW ≤ 10 ms, Duty cycle ≤ 20%

Electrical Characteristics

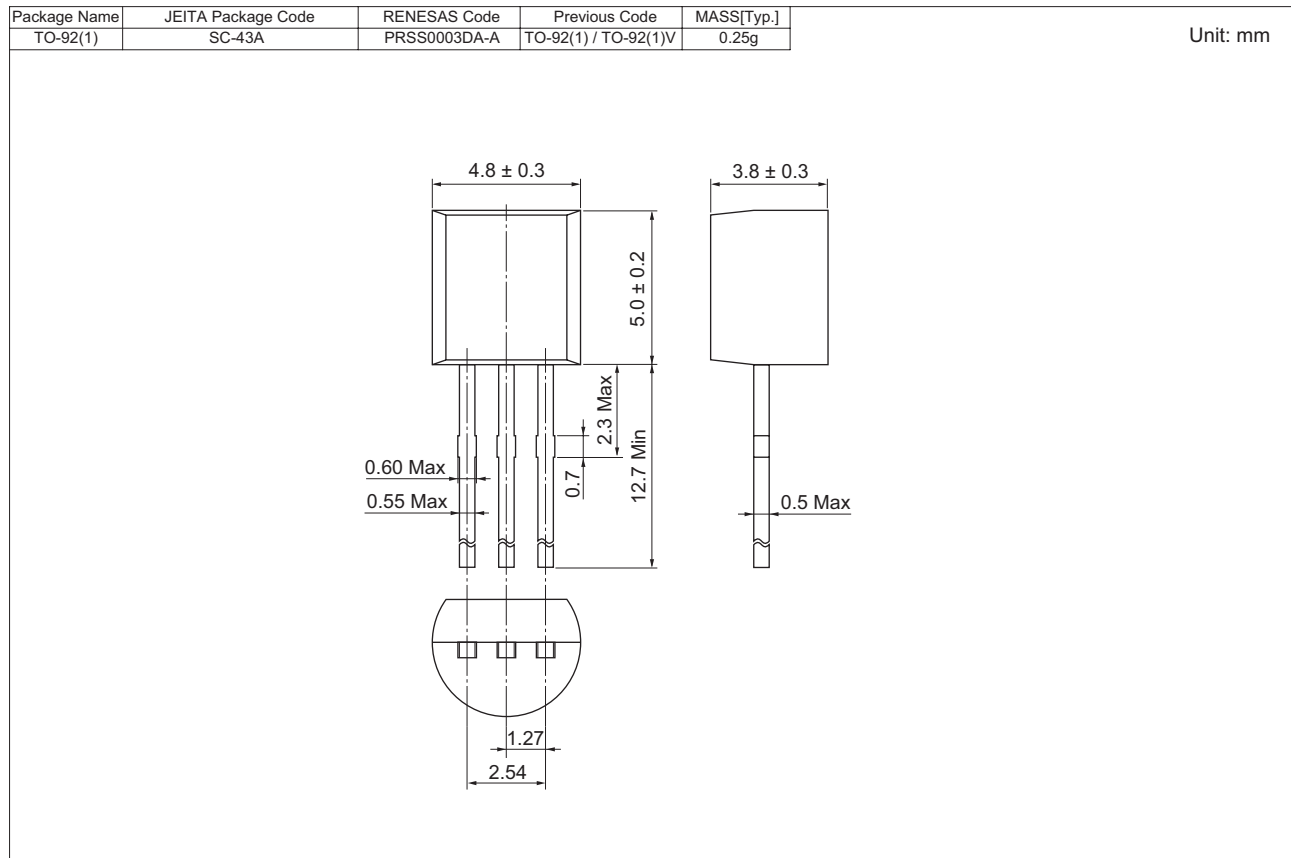
(Ta = 25°C)

| Item | Symbol | Min. | Typ | Max. | Unit | Test Conditions |
|---|---------------|------|-----|------|------|---|
| Collector to base breakdown voltage | $V_{(BR)CBO}$ | -50 | — | — | V | $I_C = -10 \mu A, I_E = 0$ |
| Collector to emitter breakdown voltage | $V_{(BR)CEO}$ | -50 | — | — | V | $I_C = -0.1 \text{ mA}, R_{BE} = \infty$ |
| Emitter to base breakdown voltage | $V_{(BR)EBO}$ | -5 | — | — | V | $I_E = -10 \mu A, I_C = 0$ |
| Collector cutoff current | I_{CBO} | — | — | -500 | nA | $V_{CB} = -50 \text{ V}, I_E = 0$ |
| Emitter cutoff current | I_{EBO} | — | — | -500 | nA | $V_{EB} = -5 \text{ V}$ |
| DC current transfer ratio | h_{FE1} | 60 | — | 320 | — | $V_{CE} = -3 \text{ V}, I_C = -10 \text{ mA}$ |
| Collector to emitter saturation voltage | $V_{CE(sat)}$ | — | — | -0.6 | V | $I_C = -150 \text{ mA}, I_B = -15 \text{ mA}$ |
| Base to emitter voltage | $V_{BE(on)}$ | — | — | -1.2 | V | $V_{CE} = -3 \text{ V}, I_C = -10 \text{ mA}$ |

Main Characteristics



Package Dimensions



Ordering Information

| Part Name | Quantity | Shipping Container |
|--------------|-----------|-------------------------|
| HIT673-EQ | 2500 pcs. | Bulk, Vinyl Bag |
| HIT673-TZ-EQ | 2500 pcs. | Hold Box, Radial Taping |

Note: This product is designed for consumer use and not for automotive.

Notes:

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